

50 Watts • 50 Volts • 32us, 2% & MIDS 960-1215 MHz



ELECTRICAL CHARACTERISTICS @ 25°C

Symbol	Characteristics	Test Conditions	Min	Тур	Max	Units
P _{OUT}	Output Power	P _{IN} =1.5W, Freq=960,1090,1215MHz	50	58		W
G _P	Power Gain	P _{IN} =1.5W, Freq=960,1090,1215MHz	15.2	15.9		dB
η_D	Drain Efficiency	P _{IN} =1.5W, Freq=960,1090,1215MHz	58	63		%
Dr	Droop	P _{IN} =1.5W, Freq=960,1090,1215MHz		0.4	0.7	dB
VSWR-T	Load Mismatch Tolerance	Po=50W, Freq=1090MHz, 32µ-2%			5:1	

• Bias Condition: Vdd=+50V, Idq=20mA constant current (Vgs= -2.0 ~ -4.5V typical)

FUNCTIONAL CHARACTERISTICS @ 25°C

I _{D(Off)}	Drain leakage current	$V_{GS} = -8V, V_{D} = 150V$	4	mA
I _{G(Off)}	Gate leakage current	$V_{GS} = -8V, V_D = 0V$	0.5	mA

Export Classification: EAR-99

Specifications are subject to change. Consult www.microsemi.com for local sales and technical support contacts.



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TYPICAL PERFORMACE DATA UNDER MIDS (6.4µS on 13µS off, N=256 pulses, DF=21%)

Frequency	P _{IN} (W)	Р _{оит} (W)	І _D (А)	η _D @ pulse 1 (%)	Gain (dB)	Droop @ Pulse 256 (dB)
960 MHz	1.6	57	.380	66	15.6	0.30
1090 MHz	1.6	61	.427	63	15.8	0.30
1215 MHz	1.6	62	.449	60	15.9	0.45



TYPICAL PERFORMACE DATA UNDER 32µS, DF=2%

Frequency	P _{IN} (W)	Р _{оит} (W)	І _D (А)	IRL (dB)	Gain (dB)	Droop (dB)
960 MHz	1.6	58	.039	-12	15.65	0.05
1090 MHz	1.6	62	.044	-7	15.90	0.05
1215 MHz	1.6	63	.046	-5	15.97	0.05



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0912GN-50LE/LEL Test Fixture Overall Dimension



(Dimensions shown are in inches)

Test Fixture available upon request



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0912GN-50LE 55-QQ Package Dimensions



Dim	Millimeter	Tol	Inches	Tol
А	13.970	0.250	0.550	0.010
В	4.570	0.250	0.160	0.010
С	3.860	0.330	0.152	0.013
D	1.270	0.130	0.050	0.005
E	1.020	0.130	0.040	0.005
F	1.700	0.130	0.067	0.005
G	0.130	0.025	0.005	0.001
Н	8.130	0.250	0.320	0.010
I.	45°	5°	45°	5°
J	5.080	0.250	0.200	0.010
к	2.54 DIA	0.130	.100 DIA	0.005
L	1.270	0.130	0.050	0.005
М	9.530	0.130	0.375	0.005

PIN 1: DRAIN PIN 2: SOURCE PIN 3: GATE





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0912GN-50LEL 55-QQP Package Dimensions



Dim	Millimeter	Tol	Inches	Tol
A	5.84	.25	.230	.010
В	4.06	.25	.160	.010
С	3.17	.05	.125	.002
D	1.27	.13	.050	.005
E	1.02	.13	.040	.005
F	1.57	.13	.062	.005
G	.130	.02	.005	.001
Н	8.12	.25	.320	.010
l I	45°	5°	45°	5°
J	5.08	.25	.200	.010
К	1.40	.13	.055	.005

PIN 1: DRAIN PIN 2: SOURCE PIN 3: GATE





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90-0912GN-50LEP OVERALL PALLET DIMENSION



Dimension 1.2" X.6"X.15"



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Revision History

Revision Level / Date	Para. Affected	Description
0.1 / 19 August 2016	-	Initial Preliminary Release
2 / 7 March 2016	Header, pgs 1, 4, 5, 6	Clarified packaging abiguities